

NOT RECOMMENDED FOR NEW DESIGN USE DZT5551

A Product Line of Diodes Incorporated



**ZXTN5551G** 



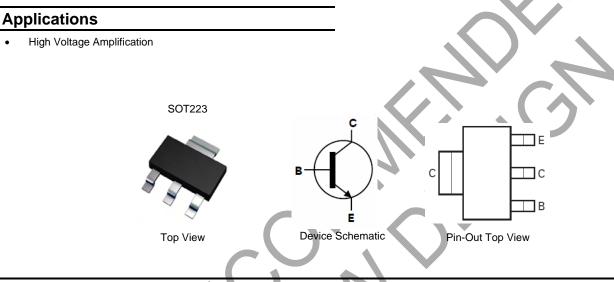
#### **160V NPN VOLTAGE TRANSISTOR**

### **Features**

- BV<sub>CEO</sub> > 160V
- BV<sub>EBO</sub> > 6V
- I<sub>C</sub> = 600mA Continuous Collector Current
- Low Saturation Voltage (150mV max @10mA)
- hFE specified up to 50mA for a high gain hold up
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## **Mechanical Data**

- Case: SOT223
- Case material: Molded Plastic. "Green" Molding Compound. UL Flammability Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Weight: 0.112 grams (Approximate)



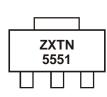
## Ordering Information (Note 4)

Part Number	Marking	Reel size (inches)	Tape width (mm)	Quantity per reel
ZXTN5551GTA	ZXTN5551	7	12	1,000
ZXTN5551GTC	ZXTN5551	13	12	4,000

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  - See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen and Antimony free, "Green" and Lead-Free.
    Halogen and Antimony free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.</li>
  - 4. For packaging details, go to our website at http://www.diodes.com

## **Marking Information**

Notes:



ZXTN5551 = Product type Marking Code





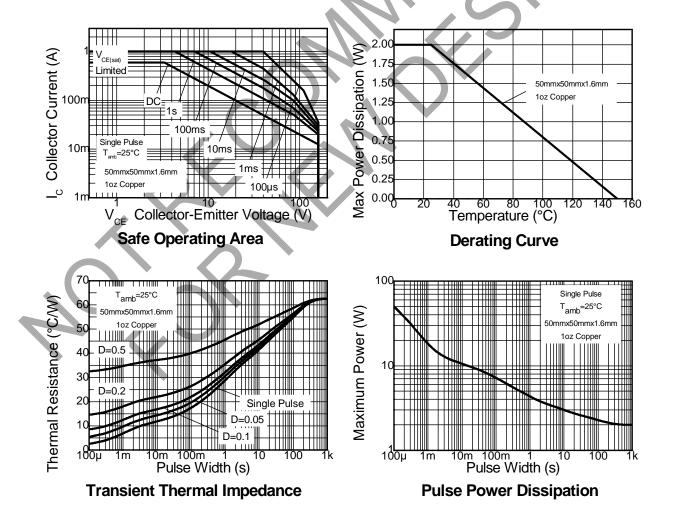
## Maximum Ratings (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	
Collector-Base Voltage	V <sub>CBO</sub>	180	V	
Collector-Emitter Voltage	V <sub>CEO</sub>	160	V	
Emitter-Base Voltage	V <sub>EBO</sub>	6	V	
Continuous Collector Current	lc	600	mA	

# **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	2	W
Thermal Resistance, Junction to Ambient (Note 5)	R <sub>0JA</sub>	62.5	°C/W
Thermal Resistance, Junction to Leads (Note 6)	R <sub>θJL</sub>	34.05	°C/W
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>STG</sub>	-55 to +150	D°

5. Device mounted on 50mm X 50mm X 1.6mm FR-4 PCB with high coverage of single sided 1 oz. copper, in still air condition Notes: 6. Thermal resistance from junction to solder-point (at the end of the collector lead).







## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Collector-Base Breakdown Voltage	BV <sub>CBO</sub>	180	270	_	V	I <sub>C</sub> = 100μA
Collector-Emitter Breakdown Voltage (Note 7)	BV <sub>CEO</sub>	160	200	—	V	I <sub>C</sub> = 1mA
Emitter-Base Breakdown Voltage	BV <sub>EBO</sub>	6.0	7.85	—	V	I <sub>E</sub> = 100μA
Collector Cutoff Current	I <sub>CBO</sub>		<1 —	50 50	nA μA	V <sub>CB</sub> = 120V V <sub>CB</sub> = 120V, T <sub>A</sub> = +100°C
Collector-Emitter Saturation Voltage (Note 7)	V <sub>CE(sat)</sub>		65 115	150 200	mV mV	$I_{C} = 10$ mA, $I_{B} = 1$ mA $I_{C} = 50$ mA, $I_{B} = 5$ mA
Base-Emitter Saturation Voltage (Note 7)	V <sub>BE(sat)</sub>	_	760 840	1000 1200	1000	$I_C = 10$ mA, $I_B = 1$ mA $I_C = 50$ mA, $I_B = 5$ mA
DC Current Gain (Note 7)	hFE	80 80 30	130 145 65	 250 		$V_{CE} = 5V, I_C = 1mA$ $V_{CE} = 5V, I_C = 10mA$ $V_{CE} = 5V, I_C = 50mA$
Transition Frequency	f <sub>T</sub>	_	130		MHz	$V_{CE} = 10V$ , $I_C = 10mA$ , f = 100MHz
Small Signal	h <sub>FE</sub>	50	-	260	- (	$V_{CE} = 10V, I_C = 10mA,$ f = 1kHz
Output Capacitance (Note 7)	C <sub>obo</sub>			6	pF	V <sub>CB</sub> = 10V, f = 1MHz
Delay Time	t <sub>(d)</sub>	-	95		ns	
Rise Time	t <sub>(r)</sub>	4	64	—	ns	$V_{CC} = 10V, I_C = 10mA,$
Storage Time	t <sub>(s)</sub>		1256		ns	$I_{B1} = I_{B2} = 1mA$
Delay Time	t <sub>(f)</sub>		140		ns	

Notes: 7. Pulse Test: Pulse width  $\leq$  300µs. Duty cycle  $\leq$  2.0%.

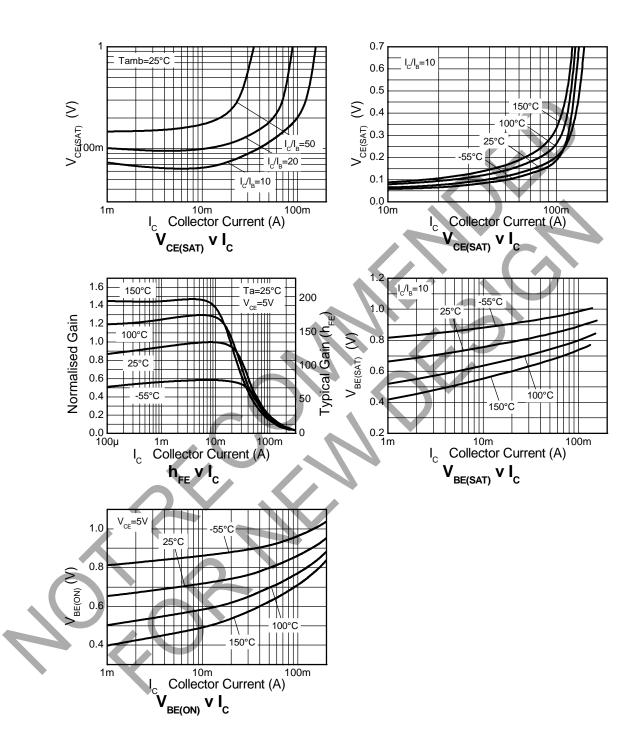


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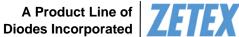
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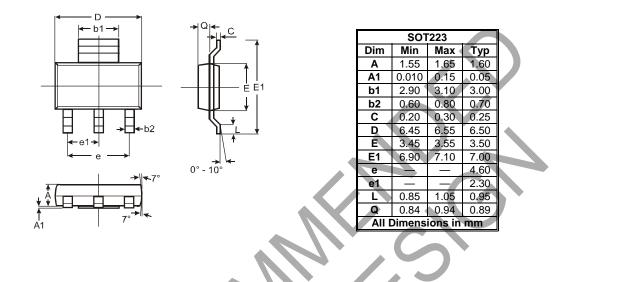






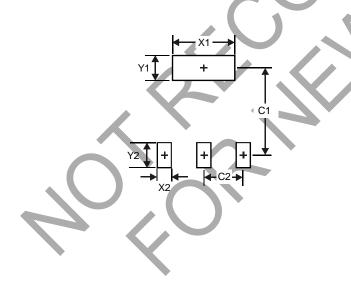
## **Package Outline Dimensions**

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for latest version.



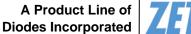
# **Suggested Pad Layout**

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
X1	3.3
X2	1.2
Y1	1.6
Y2	1.6
C1	6.4
C2	2.3







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